

Metallized Nanotube Polymer Composite (MNPC)

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Outline

- Motivation
- Approach
- SWCNT-Polymer Composites
- MNPC
- Morphology
- Physical properties
- Summary

Motivation

Why Nanomaterials in Aerospace Vehicles?



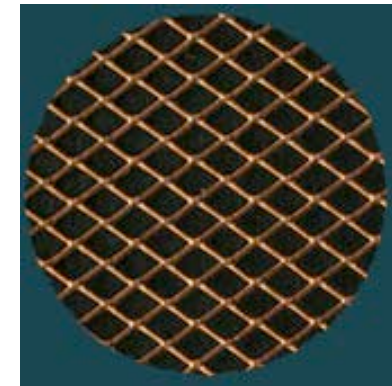
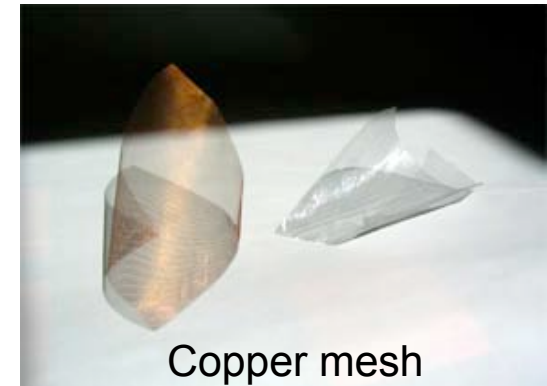
Boeing 787

YONHAPNEWS

$$\text{Aircraft Range} = \frac{\text{Velocity}}{\text{TSFC}} \left(\frac{\text{Lift}}{\text{Drag}} \right) \ln \left[1 + \frac{W_{\text{fuel}}}{W_{\text{PL}} + W_{\text{O}}} \right]$$

• Engine Fuel Consumption • Aerodynamics • Empty Weight

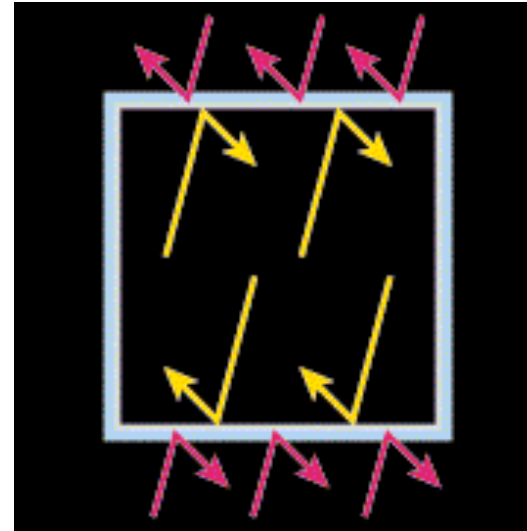
Astrostrike



- Lightweight, multifunctional composite aerospace vehicles
- Lack of Electromagnetic effect (EME) shielding: Lightning, EMI...
- Current methods include flame spraying of conductive coatings, use of conductive paints, woven wire fabrics, metallized cloth or fibers, conductive foils and interwoven wire in carbon fibers, copper mesh...

Copper's density is 8.9 g/cm³ and CNT's is around 1.3 g/cm³

Electromagnetic Interference (EMI) Shielding



Metal coating (electroplating...)
Poor adhesion and wear resistance
Different thermal expansion coefficient

Conductive polymer (doped)
Poor mechanical and thermal properties
Poor processibility

Approach

Metallized Nanotube Polymer Composite (MNPC)

1. lightweight, high temperature, high performance polymer matrix
2. highly strong, stiff reinforcing nanotubes
3. nanoparticle inclusions metallized by a SCF infusion method

Metal Coated Carbon Nanotubes: Increased Conductivity

- Y. Zhang, Nathan W. Franklin, Robert J. Chen and Hongjie Dai, "Metal coating on suspended carbon nanotubes and its implication to metal tube interaction," *Chem. Phys. Lett.*, 24 35-41 (2000)
- Y. Zhang and Hongjie Dai, "Formation of metal nanowires on suspended single-walled carbon nanotubes," *Appl. Phys. Lett.*, 77 3015 (2000)
- Y. Feng and H. Yuan, "Electroless plating of carbon nanotubes with silver," 39 3241 (2004)
- S. Yoshimoto et al, *Jap. J. of Appl. Phys.* Vol. 44, No. 51, 2005, pp. L1563-L1566 "Electrical Characterization of Metal-Coated Carbon Nanotube Tips"
- C. Yang et al, "Carbon Nanotube/Copper Composites for Via Filling and Thermal Management," Electronic Components and Technology Conference, 2007. ECTC '07. Proceedings. 57th
Abstract: ...**Electrical measurement of the CNT/copper composite vias demonstrates much lower electrical resistance than that of vias with CNT only...**
- HH3.73. Carbon Nanotube/Copper Composite Coatings, Fabricated by Cold Spraying. S. Kwon; D. Lee; D. Park; A. Yoon; K. Lee, MRS Fall 2007...Conductivity increased with CNT incorporation...

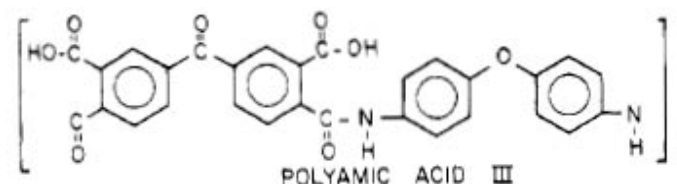
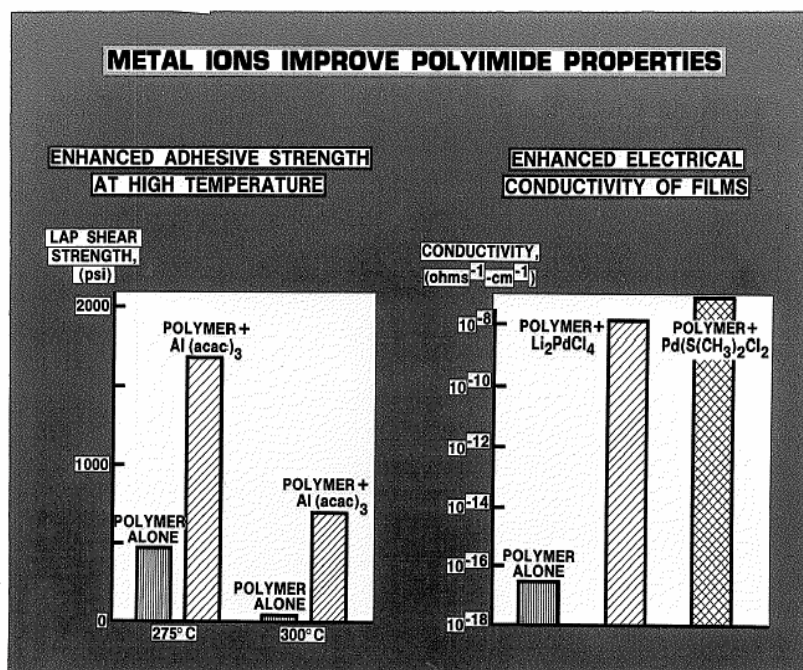
Metal Impregnation into Polymers with Metal Salts

R. J. Angelo and E. I. du Pont de Nemours & Co., US. Patent 3 073 785 (1959)
St. Clair, Carver, Taylor, Furtch, *J. Am. Chem. Soc.*, **102** 876 (1980))

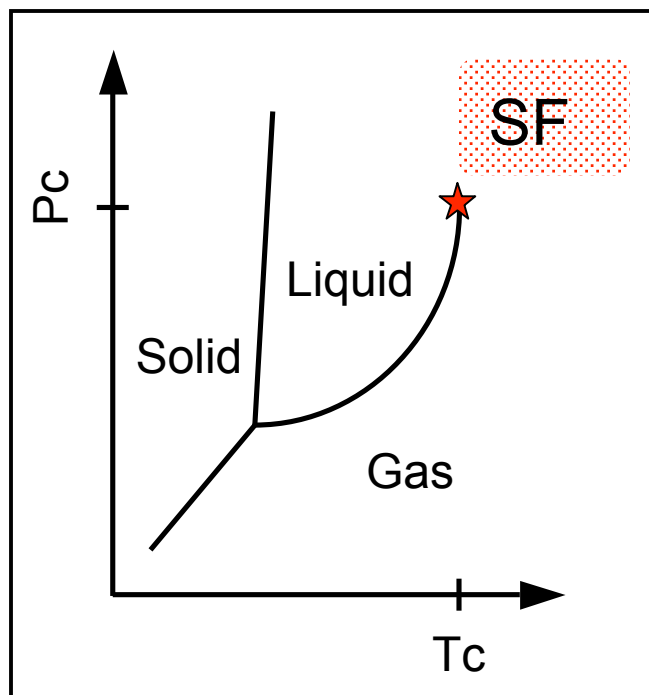
Table I. Palladium Containing BTDA-ODA-Polymer Films

films	volume resistivity, Ω cm	surface resistivity, Ω	metal content, %
polymer + Li_2PdCl_4	6.1×10^{10}	4.5×10^7 (side 1) 8.2×10^{10} (side 2)	0.17 Li 5.33 Pd
polymer + $\text{Pd}[\text{S}(\text{CH}_3)_2]_2\text{Cl}_2$	3.3×10^{10}	very low (unmeasurable)	0.23 S 7.02 Pd
polymer + Na_2PdCl_4	2.3×10^{15}	$>10^{16}$	1.36 Na 4.69 Pd
polymer alone	$\sim 1.0 \times 10^{17}$	$\sim 1.0 \times 10^{17}$	

L-81-10,399



Properties of Supercritical Fluids



- Environmentally safe (no toxic solvent)
- Lower viscosity (low surface energy)
- Higher mass transfer (diffusivity)
- Recyclable: economically beneficial
- Controllable dissolving power

	SF	Liquid
Viscosity [Pa.s]	10^{-4}	10^{-3}
Diffusivity [m^2/s]	10^{-7} - 10^{-8}	$< 10^{-9}$

- CO_2 ($T_c=31^\circ\text{C}$, $P_c=73\text{bar}$) is the most used supercritical fluid with a small amount of solvent to increase elutropic strength

Supercritical Impregnation on polymers

First demonstration by A. R. Berens in 1986

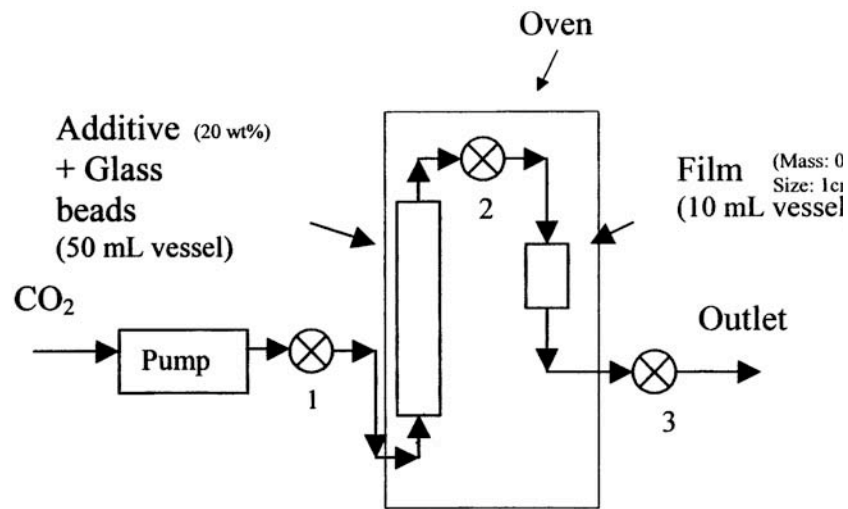
A. R. Berens et al, *J. Appl. Polym. Sci.* **46** 231 (1992)

A. R. Berens et al, (Eds.), *Supercritical Fluid Science and Technology*, 1989 ACS Symp. Ser. 406, Chapter 14.

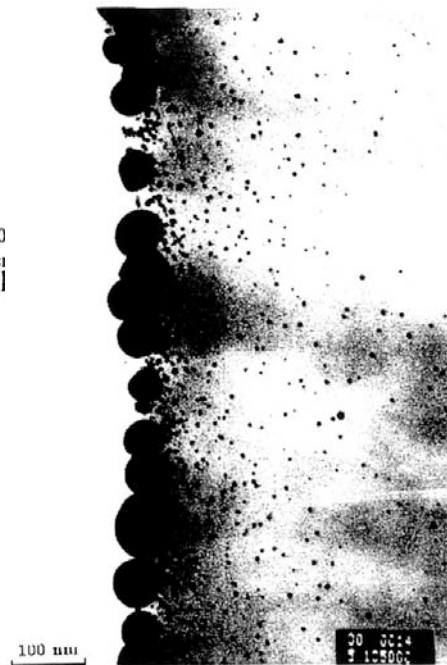
Critical Factors in the Success of Supercritical Fluid Metal Impregnation with a Polymer Substrate

1. Solubility of metal precursor in the SF
2. Diffusion of SF into the polymer
3. Partition of metal precursor between SF and polymer
4. Reduction of metal precursor to the metallic state

Schematic of SCF Infusion process



1. Pressurize additive vessel (15 min): valve 1 open, valve 2 and 3 closed
2. Impregnation step (120 min): valve 1 closed, valve 2 open, valve 3 closed
3. Decompression step: valve 1 and 2 closed, valve 3 open



TEM: Ag-PEEK



TEM: Ag-PS

Experimental

Materials

Impregnated films: SWNT/polyimide films

Polyimide: (β -CN)APB-ODPA: (bCN-AO), PMDA-ODA,

SWNT: 0, 0.035, 0.075, 0.1, 0.2, 1, 2, 5, and 10wt% (HiPco, Honda, CSI P2 & P3)

Supercritical fluid (CO_2) impregnation of $[\text{Ag}(\text{COD})(\text{HFA})]_2$,
(1,5-cyclooctadien-1,1,1,5,5,5-hexafluoroacetylacetonato) silver(I) dimer, followed by
thermal reduction of the silver-containing film to silver metal.

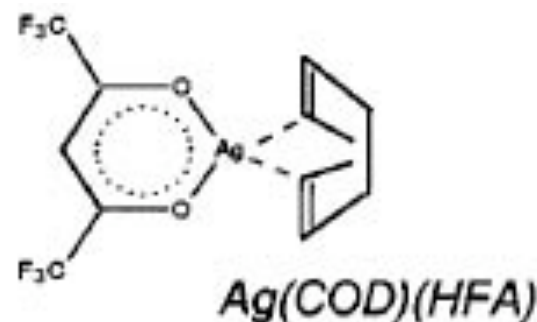
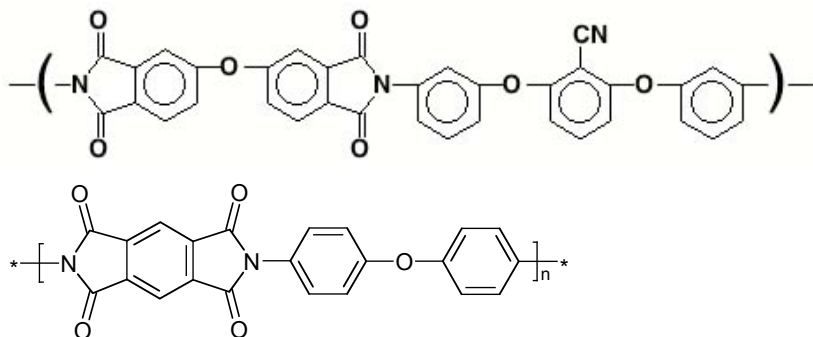
Instruments

Applied Separations (Allentown, PA) supercritical fluid system (Spe-ed SFE)

Impregnation condition: 20-90wt% salt and glass beads (1/3 volume of the vessel)

345 atm (5000psi) CO_2 pressure at 150°C for 1hr ([345/150/1](#))

Reduction condition: 250°C for 1hr ([250/1](#))



How to disperse CNTs?

1) Kinetic Approach

High shear (stirring, homogenization)

Sonication (cavitation force)

Melt mixing (twin screw mixer, extruder, capillary rheometer, fiber spinning)

In-situ polymerization

In-situ polymerization under sonication & high shear (Park et al, *Chem. Phys. Lett.* **364**, 303 (2002))

2) Thermodynamic Approach

Covalent bonding

Acid etching

Stirring, reflux, and soxhlet extraction with H_2SO_4 , HNO_3 , and HCl

Functionalization

Fluorination, reflux with amine, electrochemical (diazonium compound)

Non-covalent bonding

Amphiphilic (surfactant), hydrophobic interaction: Water soluble polymers

Wrapping: PmPV, Polyvinyl pyrrolidone, Polystyrene sulfonate, PPE

Charge Transfer (Donor-acceptor) (*Chem. Phys. Lett.* **391**, 207 (2004))

Dispersion Interaction

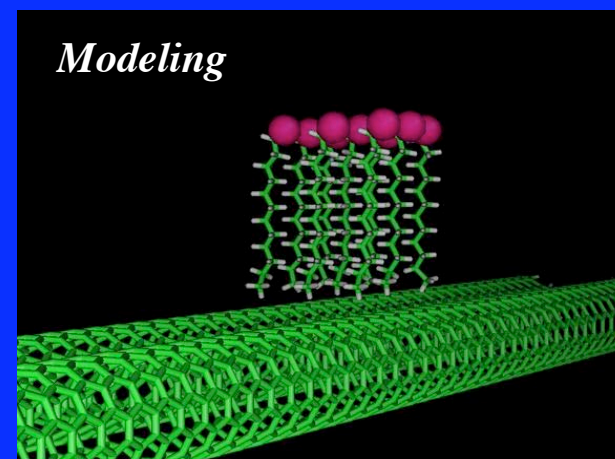
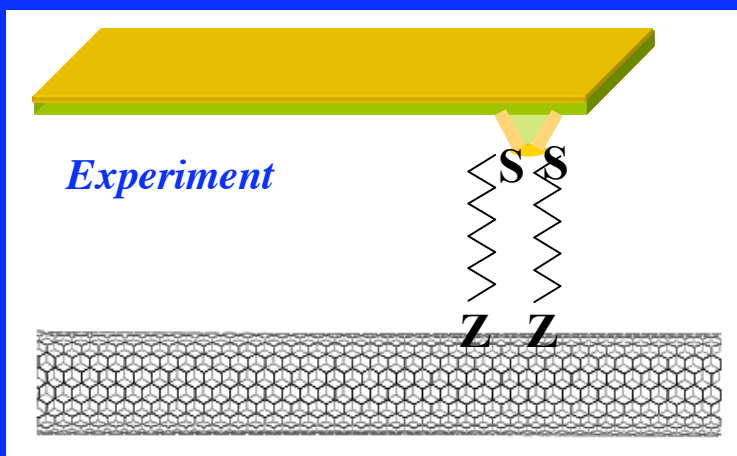
Zwitterion

Complex formation

Nonspecific interaction

Probe Microscopy

- Using Functionalized AFM tips interaction forces can be directly probed.

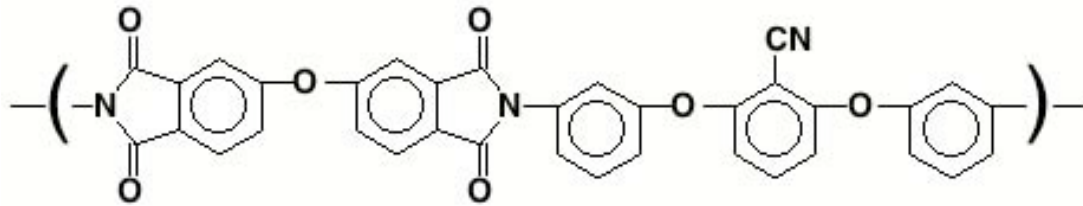


Alkyl-thiol	Force/molecule (pN)	
Endgroup	Experiment	Modeling
-OH	9.6 ± 2	
-perfluoro	8.7 ± 3	
-SH	9.2 ± 3	
-CH=CH ₂	8.1 ± 2	
-CH ₃	7.6 ± 2	1.92
-COOH	12.2 ± 3	
-NH ₂	23.4 ± 4	2.98
	GIT	K. Wise (NIA)

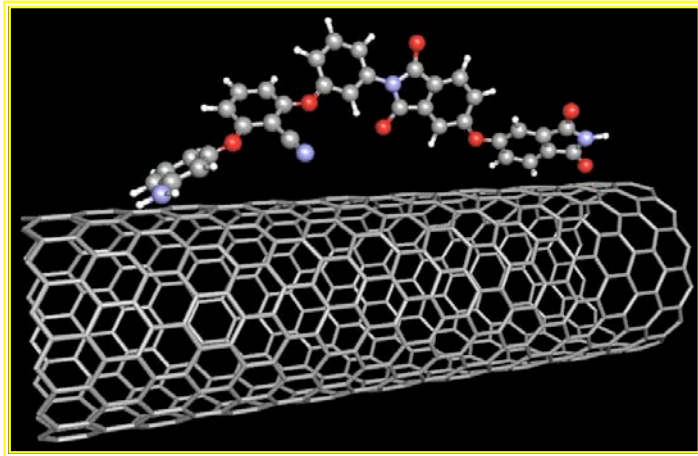
Aryl-thiol	Rupture Force per molecule (pN)	Standard Deviation
Thiol		
4-Methylbenzene	18.94	5.65
4-Nitrobenzene	21.79	5.29
4-Aminebenzene	22.64	4.66
4-Bromobenzene	26.92	3.55
4-Hydroxybenzene	32.00	8.39
4-Fluorobenzene	39.47	8.84
4-Methoxybenzene	41.51	10.9
H-Benzene	46.79	11.79
4-Nitrilebenzene	56.93	15.47

SWNT/Polymer Nanocomposites

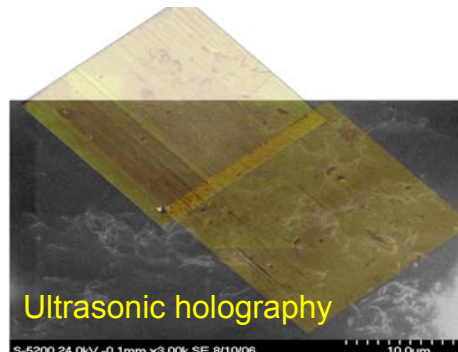
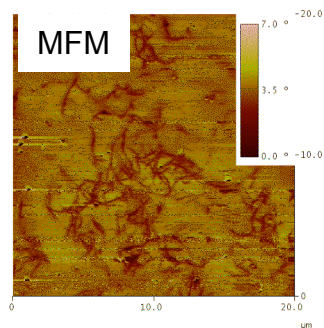
Electroactive High Performance Polyimide



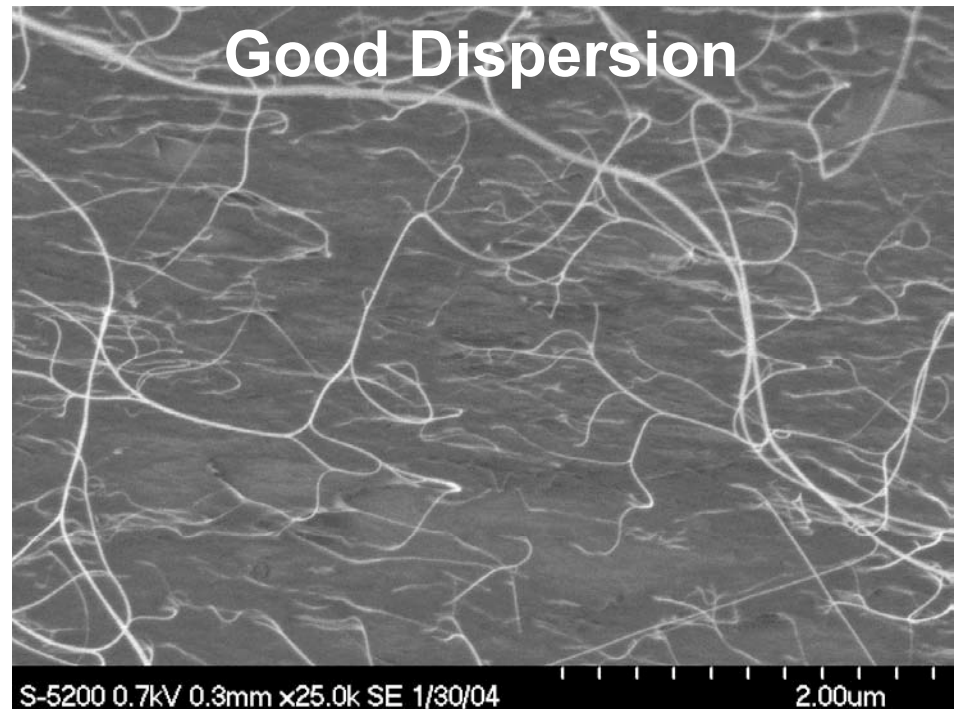
(β -CN)APB/ODPA ($T_g = 220^\circ\text{C}$)



Polyimide + SWNT

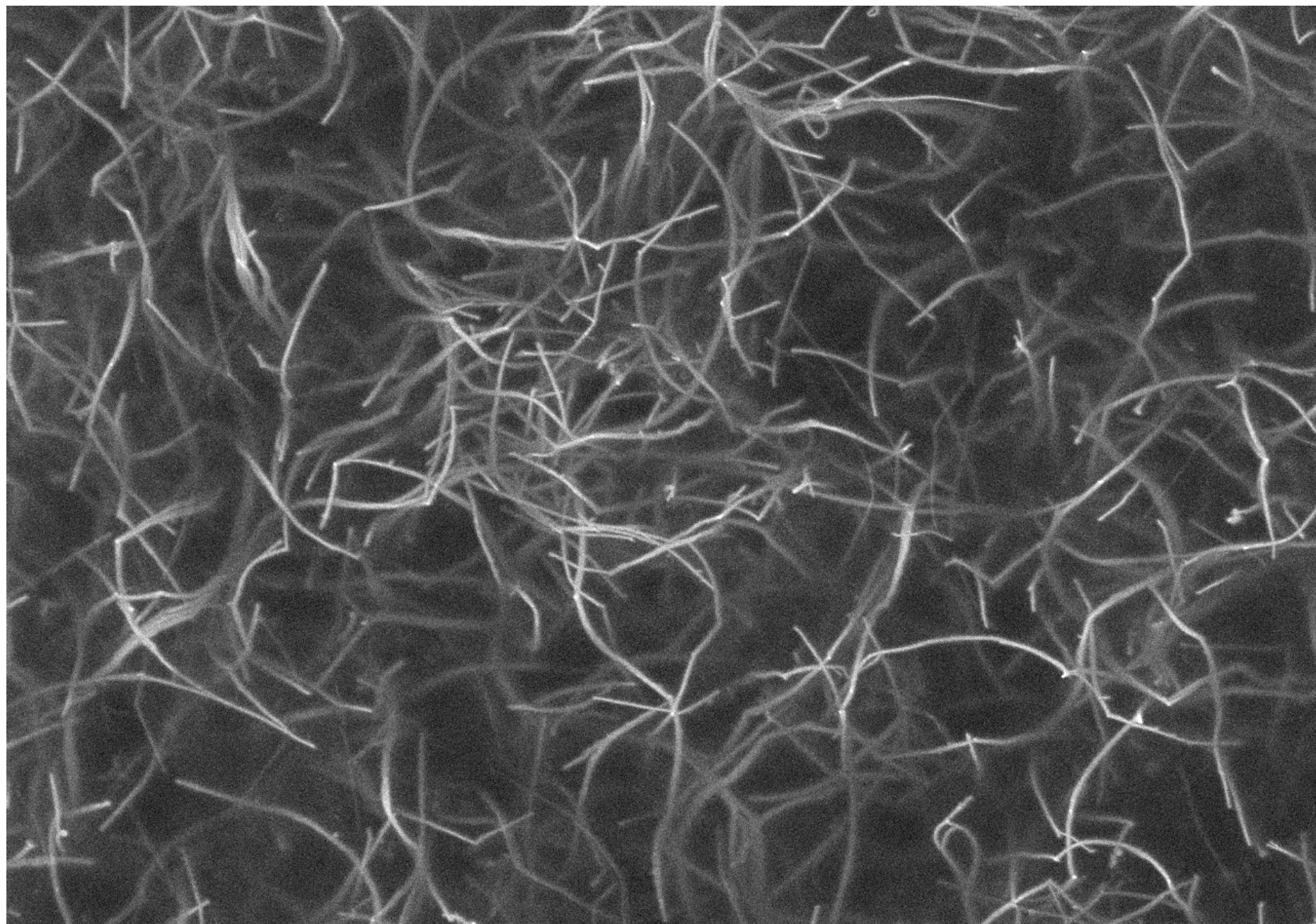


- Dispersion Interaction
- Donor-Acceptor interaction
- In-situ Polymerization under sonication and shear



Chem. Phys. Lett., **364** 303 (2002)

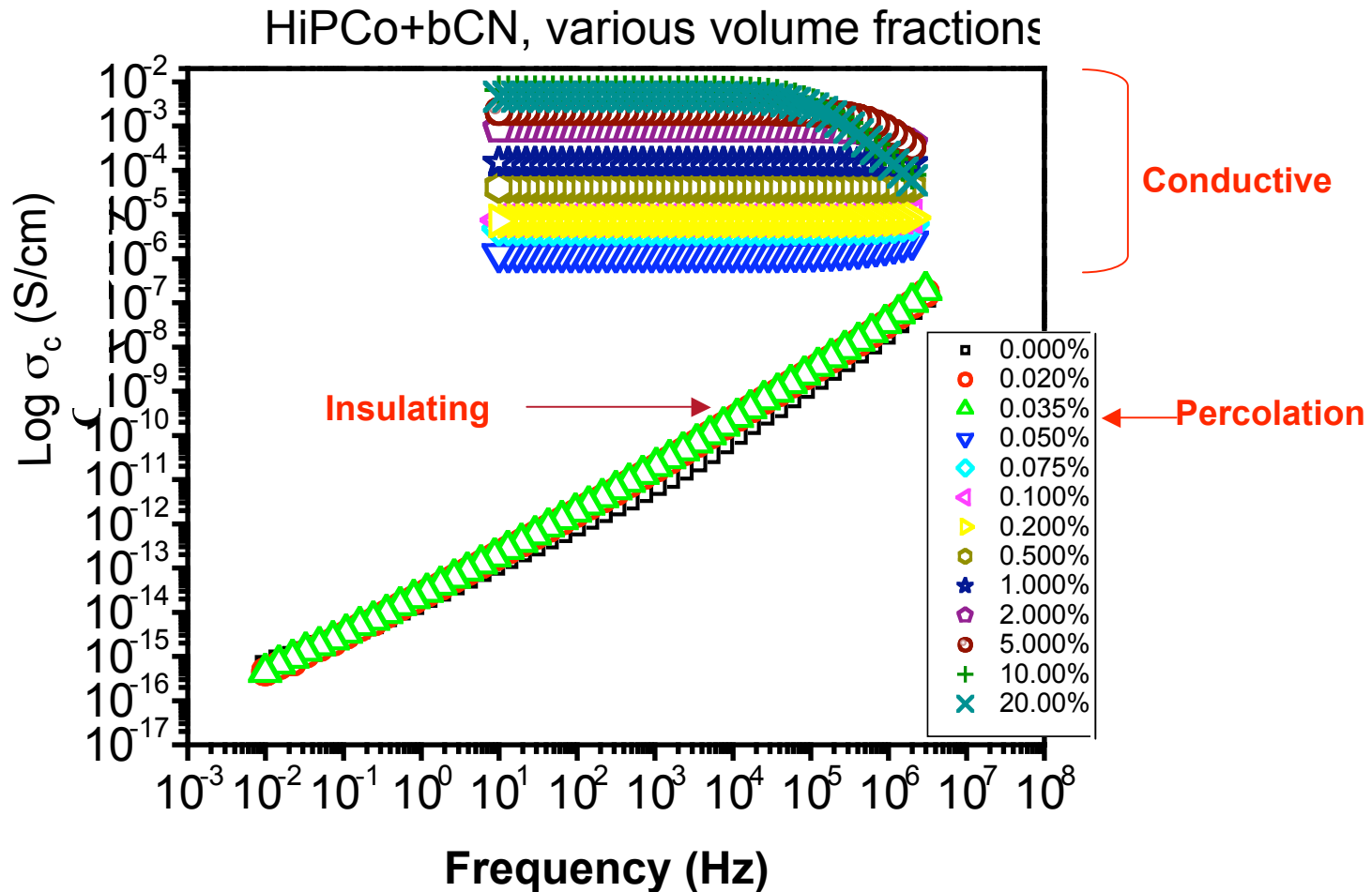
Chem. Phys. Lett. **391** 207 (2004)



S-5200 15.0kV -0.4mm x10.0k SE 7/13/06

5.00um

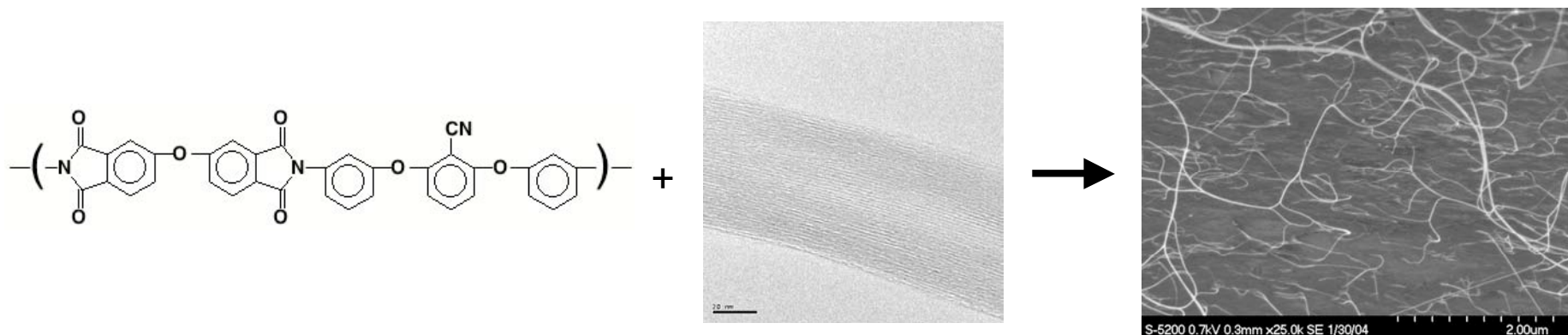
AC Conductivity of SWNT/Polyimide Nanocomposites



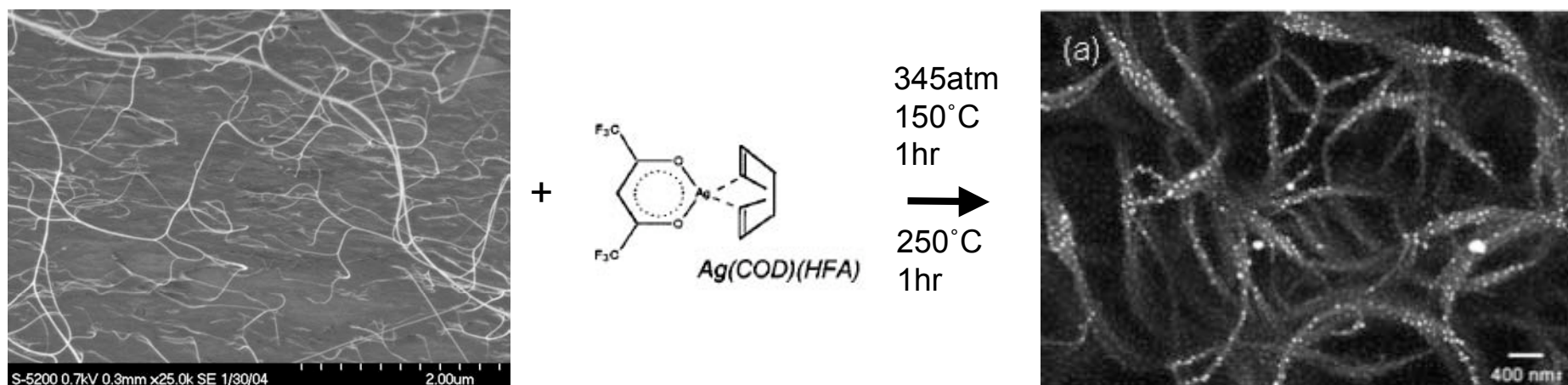
Good dispersion --> Low percolation threshold < 0.05%

NMPC: Silver Infusion Process into SWNT/(β -CN)APB-ODPA Film

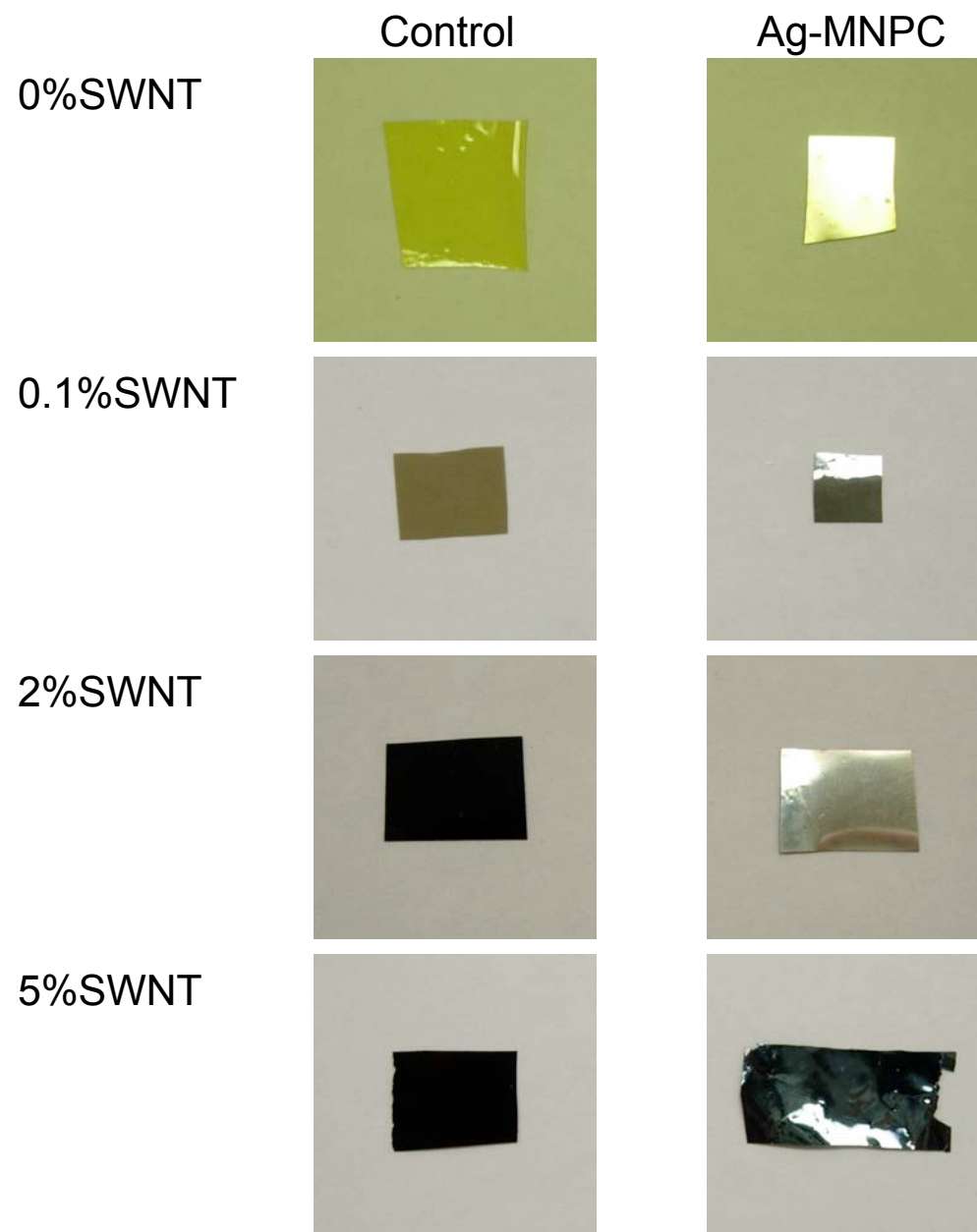
SWNT/polyimide film formation: good dispersion



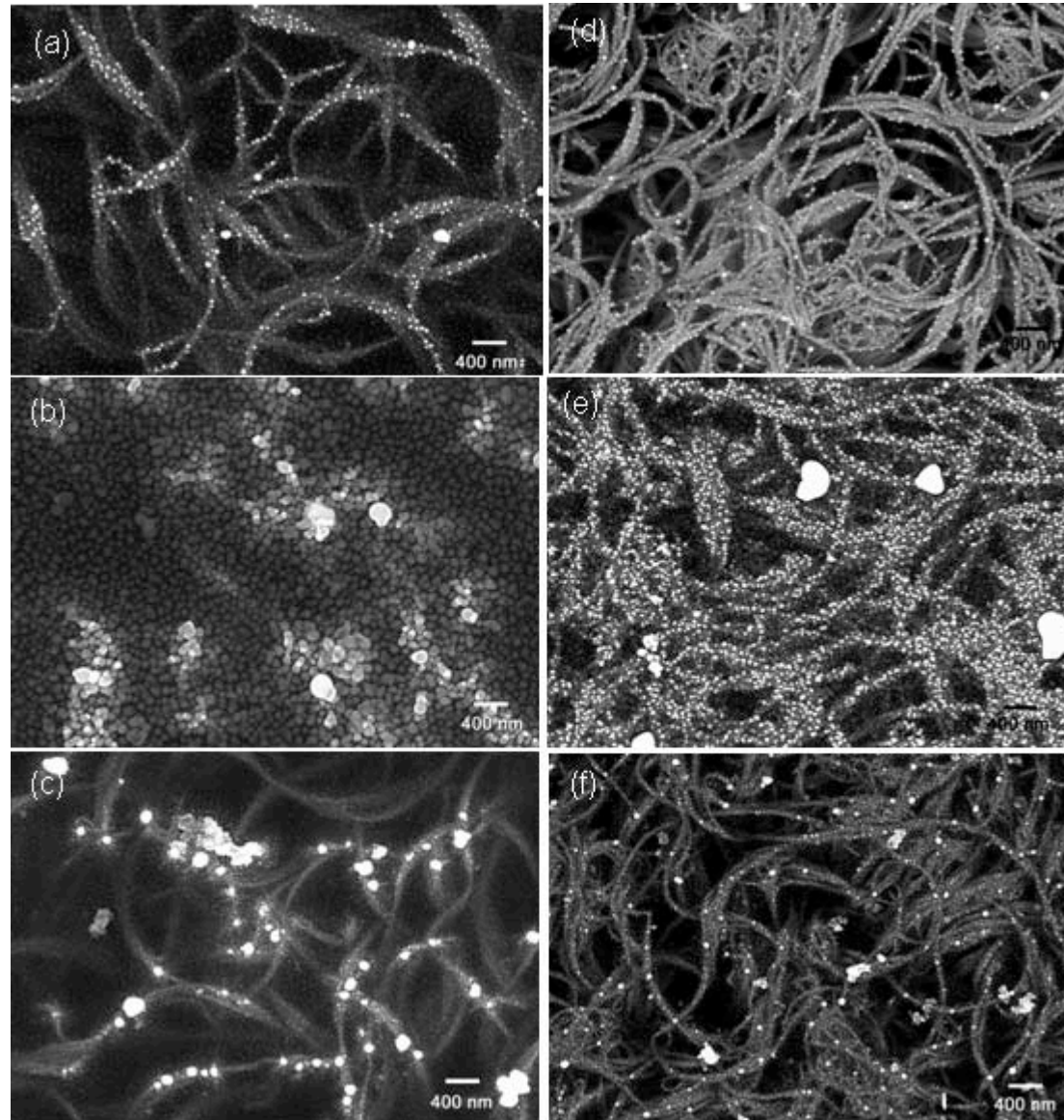
Ag-MNPC (Ag/SWNT/polyimide) film formation: SCF Ag impregnation



Ag-MNPC Films with various SWNT Concentration

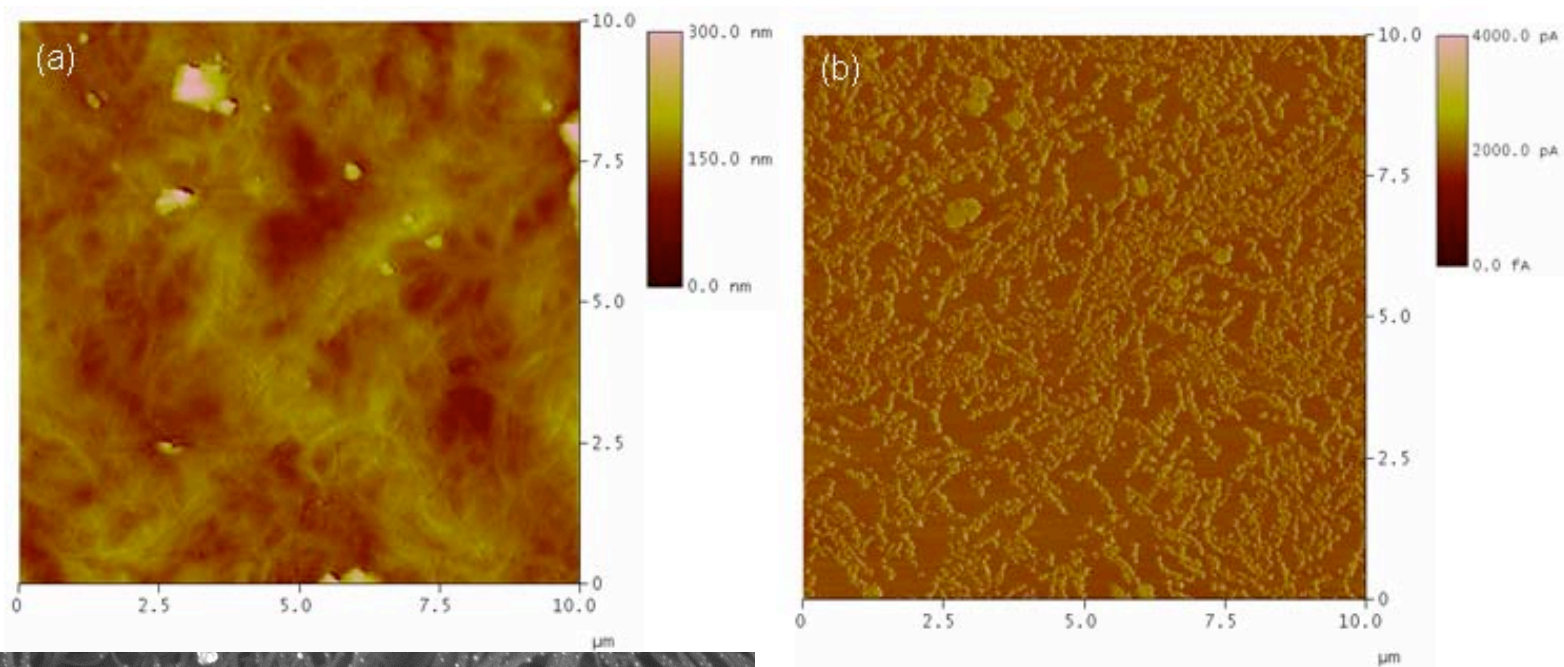


HRSEM: Polytransparency: MNPC: Ag/SWNT/ β CN AO

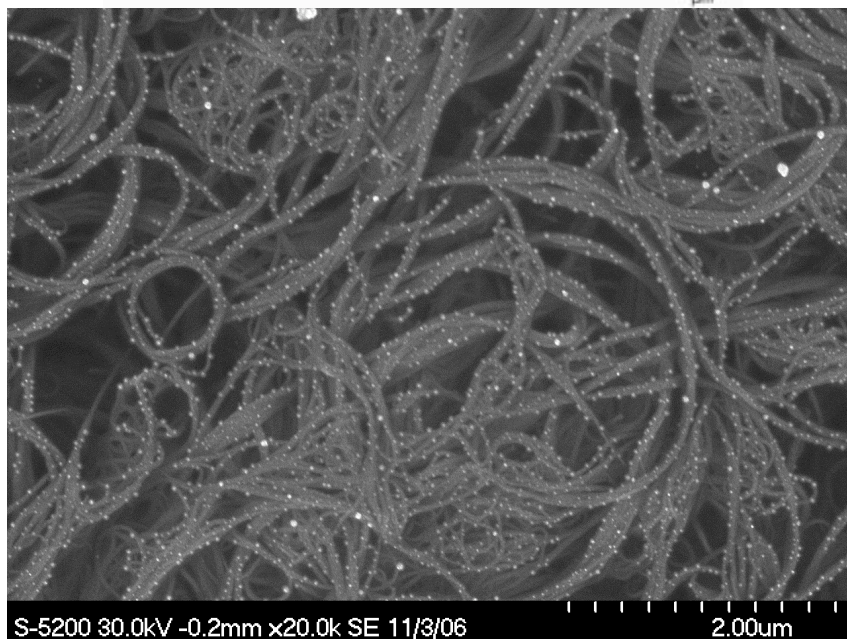


HR-SEM images of MNPCs at a high accelerating voltage: Ag/1 wt% SWNT/ β -CN AO prepared by (a) 20 % and (b) 70 % metallization solutions, and Ag/10 wt% SWNT/ β -CN AO prepared by (d) 20 % and (e) 70 % metallization solutions after curing. (c), (f) 1 wt% and 10 wt% SWNT/ β -CN AO/Ag samples prepared by 70 % metallization solution before curing, respectively.

Tunneling AFM & HRSEM: Ag-MNPC: Ag/10%SWNT/ β CN AO

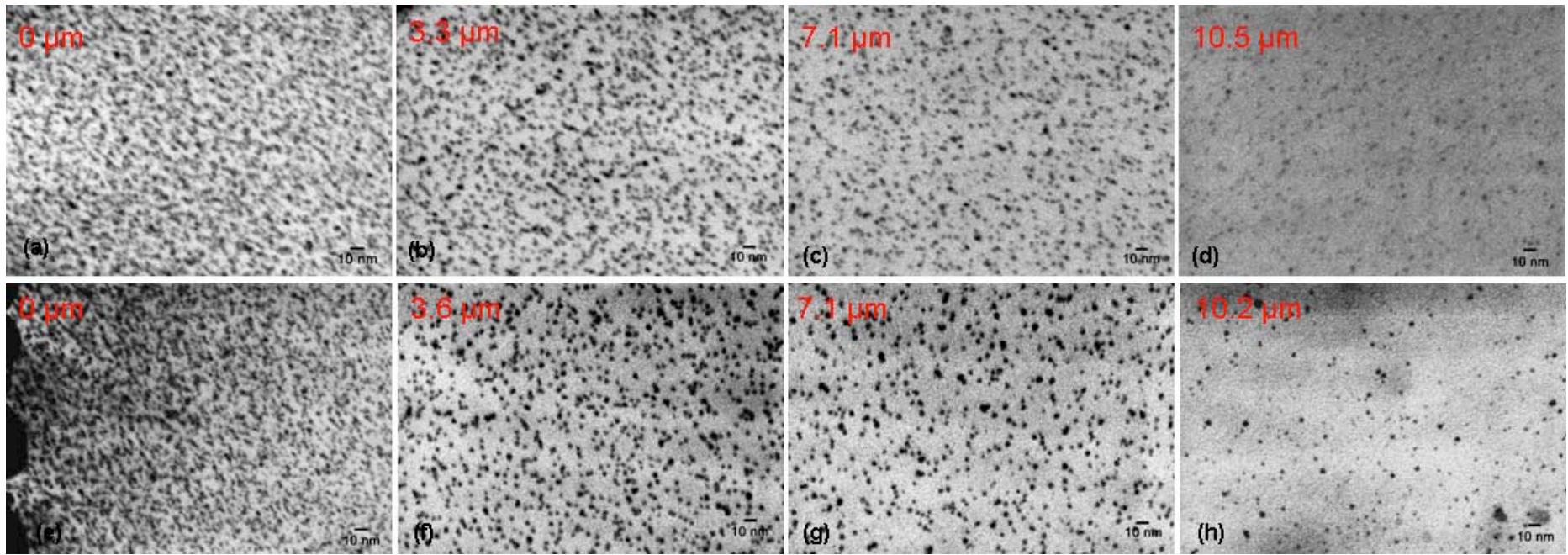


Above: Topograph and tunneling AFM images of 10 wt.% SWNT/b-CN AO/Ag prepared by 20 % metallization solution.



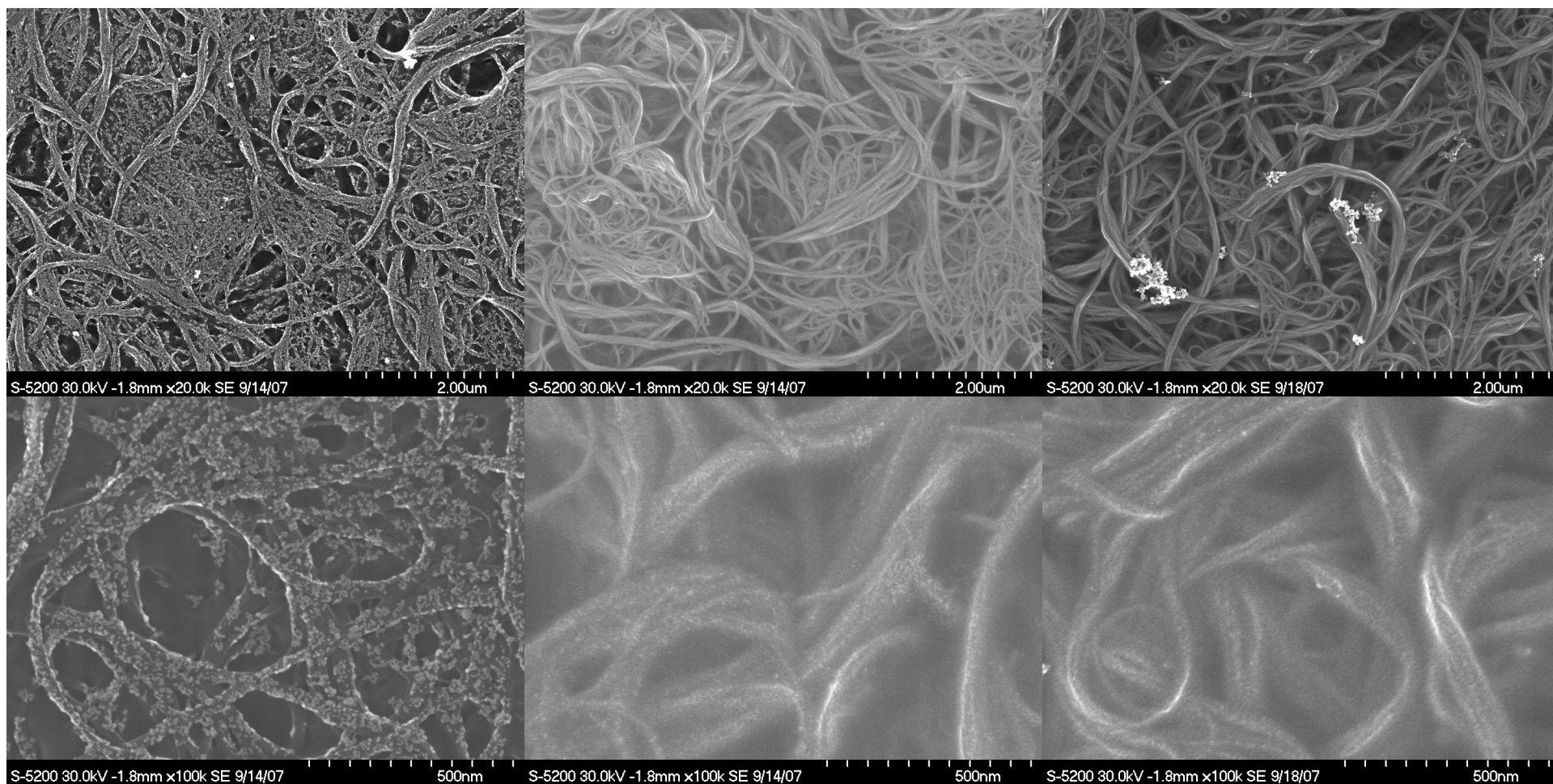
Left: HRSEM micrograph of 10 wt.% SWNT/b-CN AO/Ag prepared by 20 % metallization solution.

HRSEM: STEM (microtomed) : MNPC: Ag/0.1%SWNT/ β CN AO



STEM images of b-CN AO/Ag samples taken at specific locations from the surface with 0.1 wt.% SWCNT (e ~ h) and without SWNT (a ~ d). Samples are prepared by the supercritical fluid method with 70 % metallization solution and then microtomed to visible inside morphology.

Pt, Ni, Fe-MNPCs

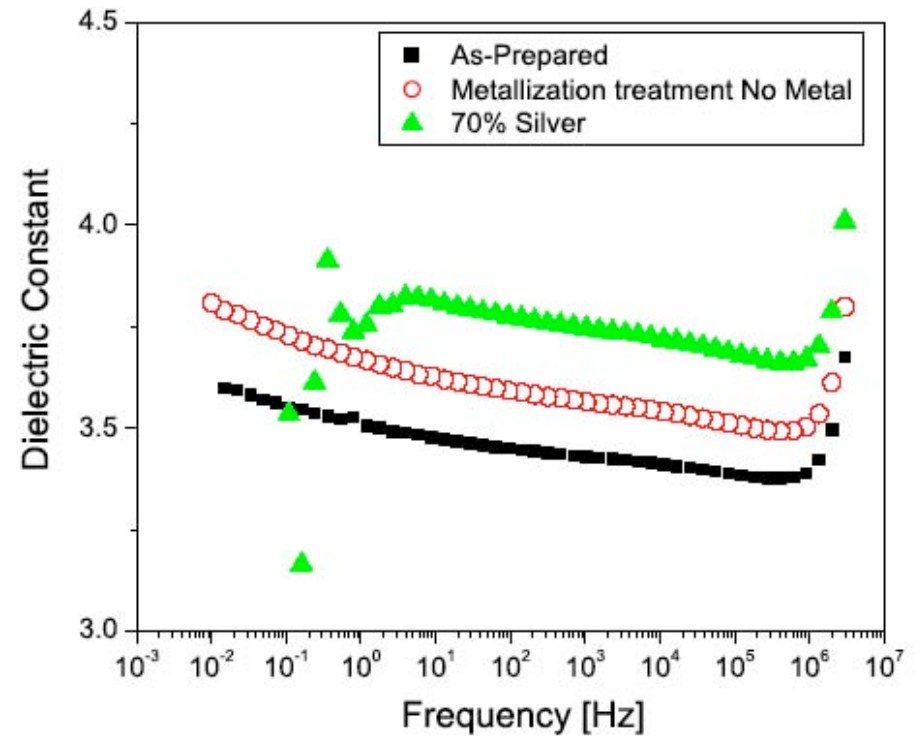
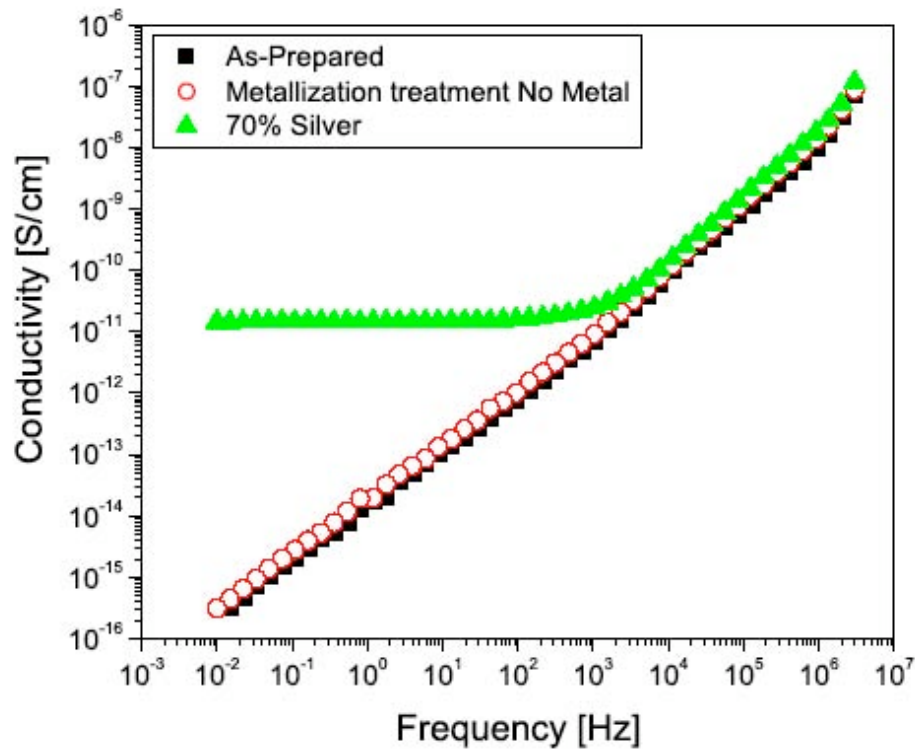


(a) Pt/10%SWNT/βCNAO

(b) Ni/10%SWNT/βCNAO

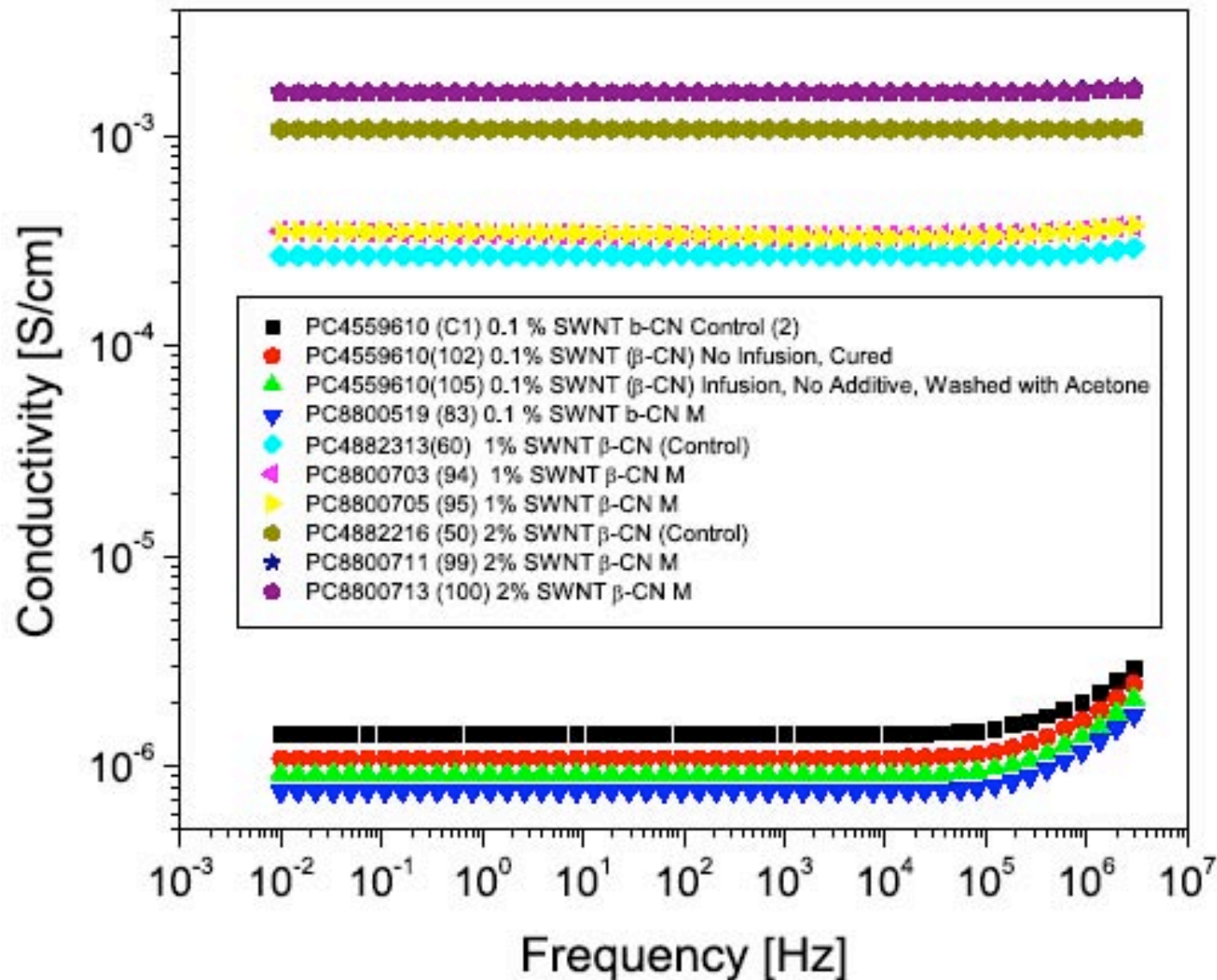
(c) Fe/10%SWNT/βCNAO

Ag-MNPC: 0.1% Honda SWNT/Polyimide



NMPC: Nanotube Metallized Polymer Composites

M-SWNT Composites and controls



Conductivity of MNPC

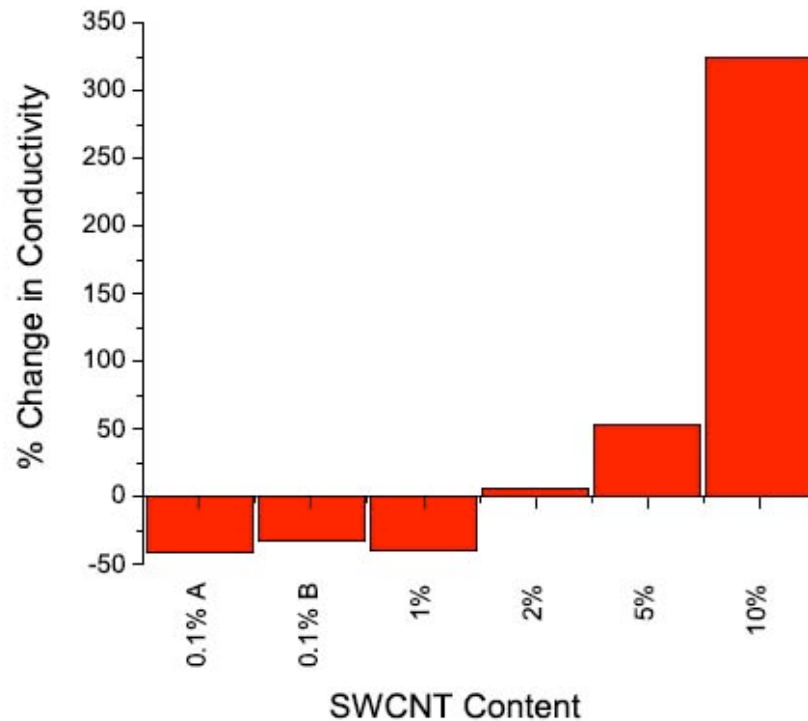


Figure 1: Summary of the change in the low frequency conductivity of metallized samples (70% metal) with different SWCNT content. The changes are calculated relative to unmetallized control samples. Below a 2% SWCNT loading, the increase in the conductivity from the added metal is not enough to overcome the decrease due to processing of the samples. At 2% and above, the conductivity of the metallized samples increases by as large as 300% at 10% SWCNT.

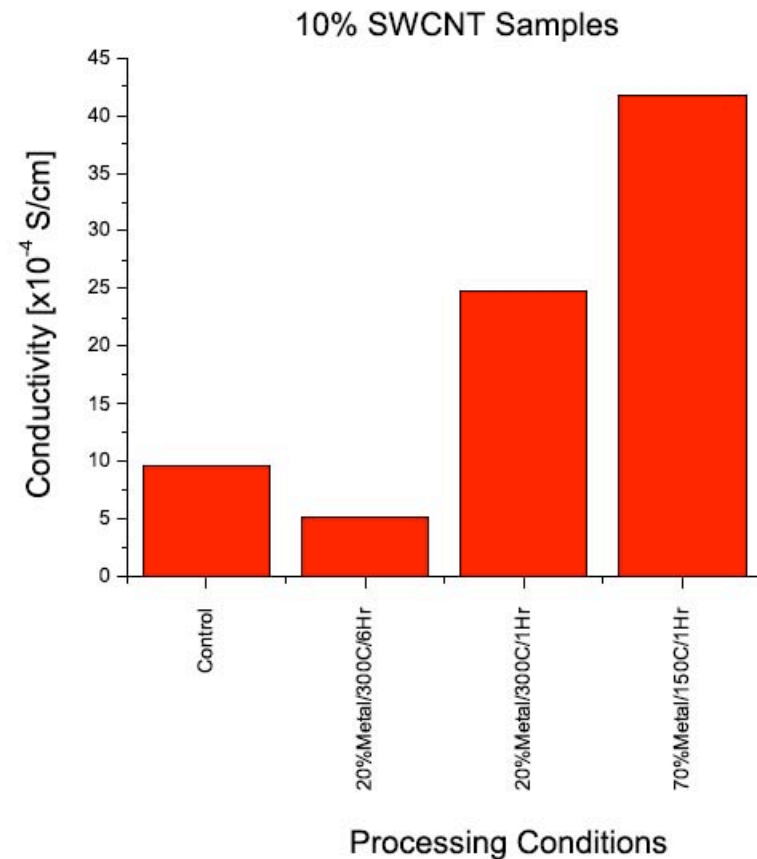
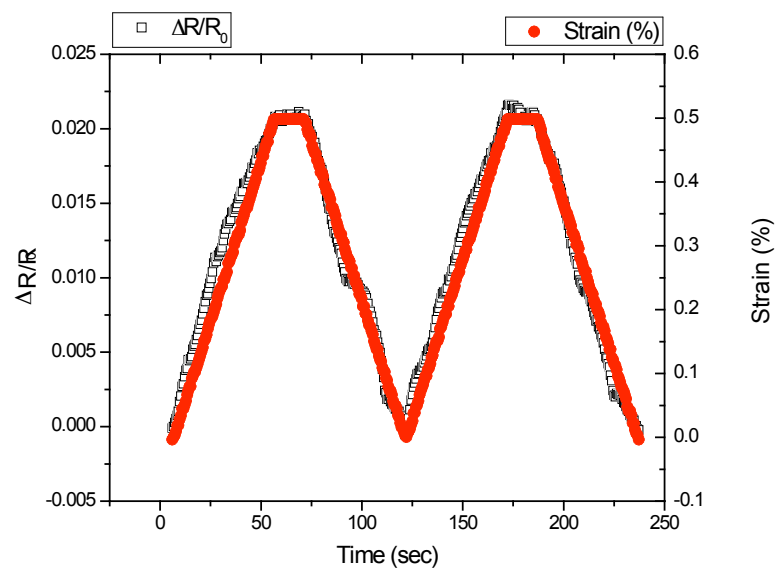
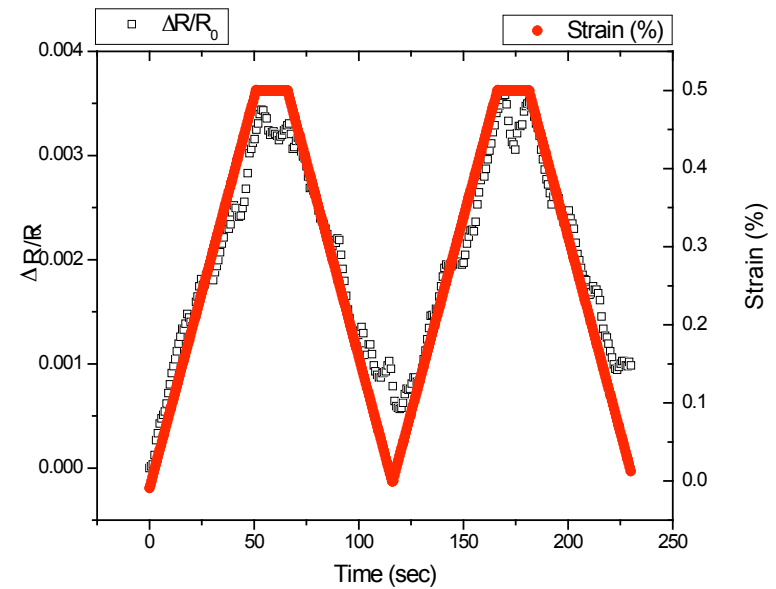


Figure 4: The effects of different metal concentration and processing conditions on the low frequency conductivity of samples containing 10% SWCNT

Piezoresistivity Measurement of SWNT/polyimide Film



0.05%SWNT/Polyimide
0.5%strain --> $\Delta R/R_0 = 0.02$



10%SWNT/Polyimide
0.5%strain --> $\Delta R/R_0 = 0.0035$

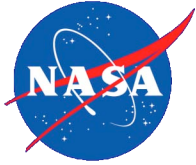
Summary

- Successful metallization into polyimide and SWNT/polyimide (Ag, Pt, Fe, Ni...)
- Preferential deposition of metal on the nanotube surfaces
- Increased conductivity with metallization
- Surface reflectivity (metallic appearance) increased with metallization
- Increased conductivity with higher metallization concentration
- Conductivity and reflectivity can be controlled by the SCF infusion conditions
- Increased toughness with SCF Infusion Process (with or without metal salts)
- No catalysts or reducing agents are required to reduce metals from the salts on CNTs

Future Research Plan

- Optimization
- Free volume measurement (PALS)
- EMI shielding test
- Lightning test

Acknowledgements



NASA Langley Research Center

Nancy Holloway

Advanced Materials and Processing Branch



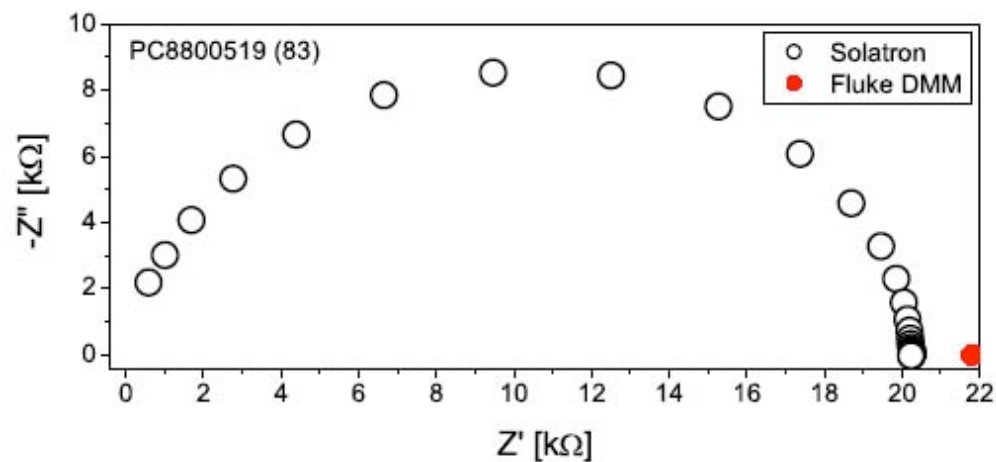
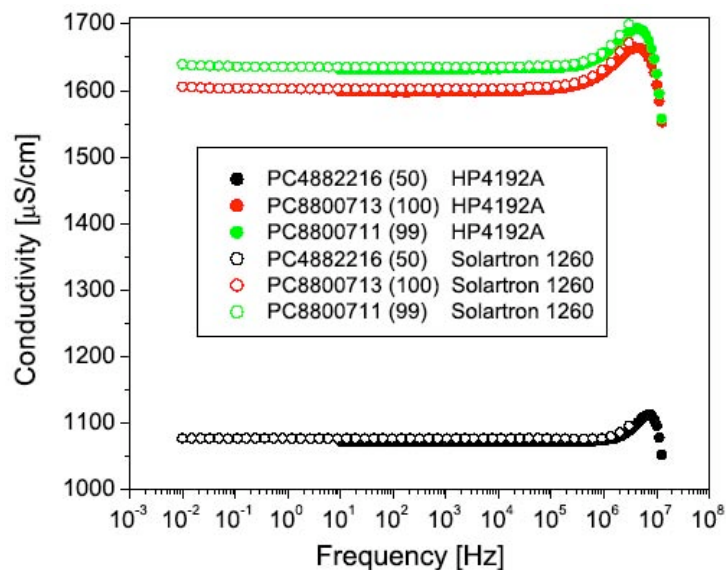
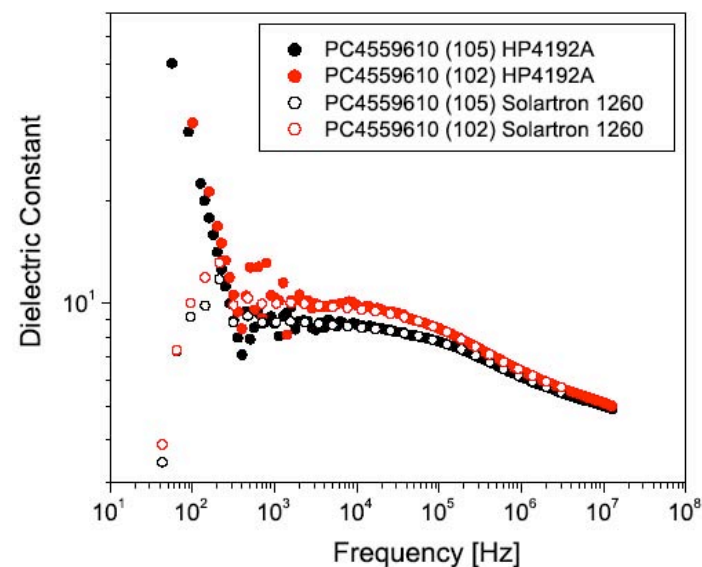
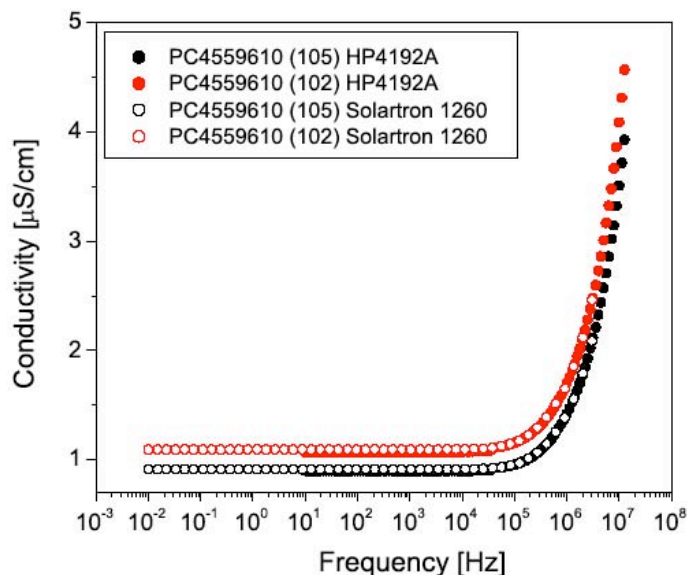
Acknowledgements for partial support by the NASA University Research, Engineering and Technology Institute (URETI) on BioInspired Materials (BIMat) under Award No. NCC-1-02037



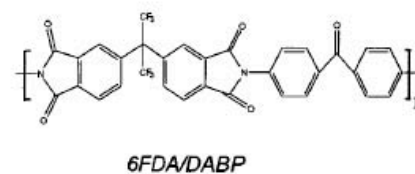
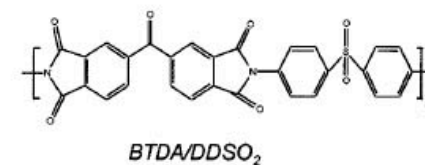
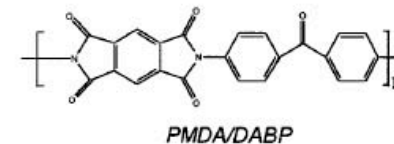
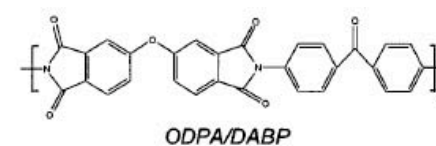
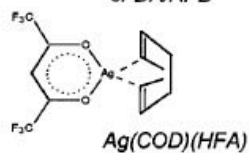
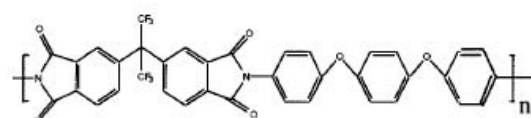
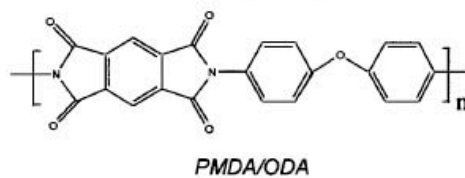
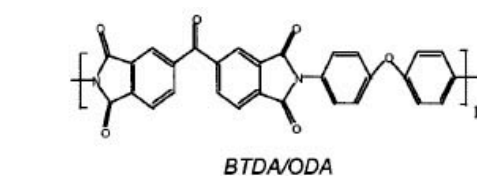
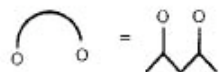
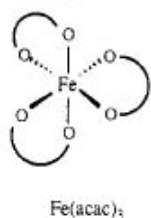
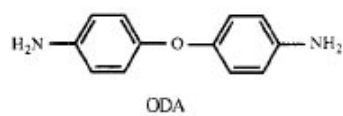
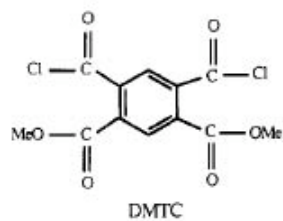
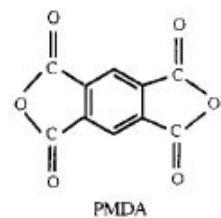
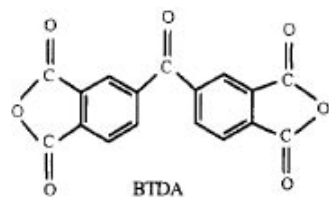
DARPA Revolutionizing Prosthetics

DARPA SkyWalker

Reliable Measurement: HP4192A vs Solartron 1260



Complex impedance plane plot of the data from a Solartron measurement and a dc measurement on the Fluke DMM. The resistance measurement on the DMM is consistent with the low frequency intercept of the impedance arc. (It is expected for the directly measured dc resistance to be slightly higher than the arc intercept as observed here).



Bergmeister, *Chem. Mat.* **4** 792 (1992)

Rosolovsky.Taylor *J. Mater. Res.* **12** 3127 (1997)